

# CY25AAJ-8F

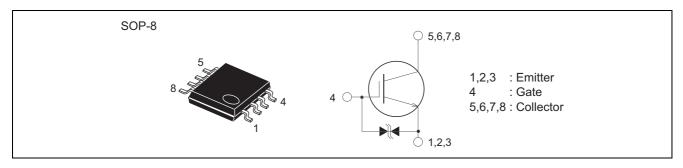
# Nch IGBT for Strobe Flasher

REJ03G0283-0100 Rev.1.00 Aug.20.2004

#### **Features**

V<sub>CES</sub>: 400 V
 I<sub>CM</sub>: 150 A
 Drive voltage: 4 V

#### **Outline**



## **Applications**

Strobe flasher for cameras

## **Maximum Ratings**

 $(Tc = 25^{\circ}C)$ 

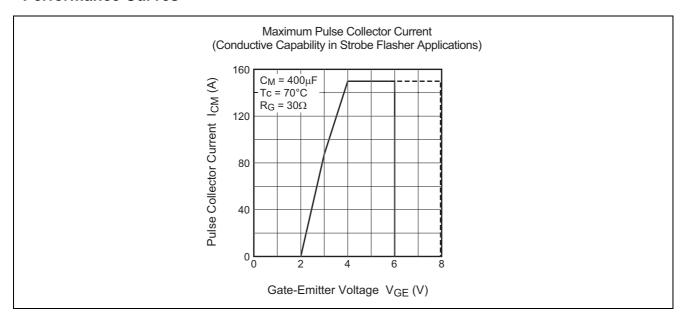
Parameter	Symbol	Ratings	Unit	Conditions
Collector-emitter voltage	V <sub>CES</sub>	400	V	V <sub>GE</sub> = 0 V
Gate-emitter voltage	V <sub>GES</sub>	±6	V	V <sub>CE</sub> = 0 V
Peak gate-emitter voltage	$V_{GEM}$	±8	V	$V_{CE} = 0 \text{ V}, \text{ tw} = 10 \text{ s}$
Collector current (Pulse)	I <sub>CM</sub>	150	Α	C <sub>M</sub> = 400 μF
				(see performance curve)
Junction temperature	Tj	- 40 to +150	°C	
Storage temperature	Tstg	- 40 to +150	°C	

#### **Electrical Characteristics**

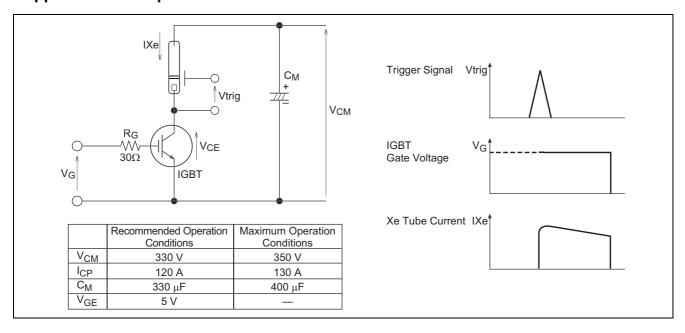
 $(Tch = 25^{\circ}C)$ 

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions
Collector-emitter breakdown voltage	$V_{(BR)CES}$	450	_	_	V	$I_C = 1 \text{ mA}, V_{GE} = 0 \text{ V}$
Gate-emitter breakdown voltage	$V_{(BR)GES}$	±8	_	_	V	$I_G = \pm 100 \ \mu A, \ V_{CE} = 0 \ V$
Collector-emitter leakage current	I <sub>CES</sub>	_	_	10	μΑ	$V_{CE} = 400 \text{ V}, V_{GE} = 0 \text{ V}$
Gate-emitter leakage current	I <sub>GES</sub>	_	_	±10	μΑ	$V_{GE} = \pm 6 \text{ V}, V_{CE} = 0 \text{ V}$
Gate-emitter threshold voltage	$V_{GE(th)}$	_	_	1.5	V	$V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ mA}$

## **Performance Curves**



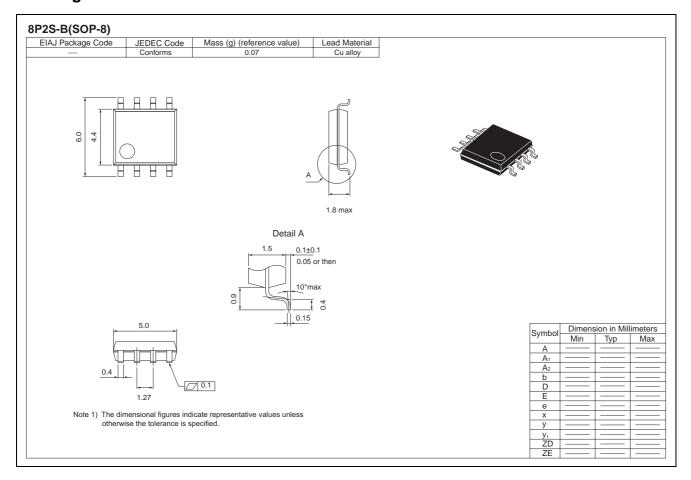
#### **Application Example**



## **Precautions on Usage**

- 1. IGBT has MOS structure and its gate is insulated by thin silicon oxide. So please handle carefully to protect the device from electrostatic charge.
- 2. Gate drive voltage during on-period must be applied to satisfy the rating of maximum pulse collector current. And peak reverse gate current during turn-off must become less than 0.1A. (In general, when  $R_{G \, (off)} = 30 \, \Omega$ , it is satisfied.)
- 3. The operation life should be endured 5,000 shots under the charge current ( $I_{Xe} \le 150~A$ : full luminescence condition) of main capacitor ( $C_M = 400~\mu F$ ) which can endure repeated discharge of 5,000 times. Repetition period under full luminescence condition is over 3 seconds.
- 4. Total operation hours applied to the gate-emitter voltage must be within 5,000 hours.

## **Package Dimensions**



#### **Order Code**

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Surface-mounted type	Taping	3000	Type name – T +Direction (1 or 2)+3	CY25AAJ-8F-T13
Surface-mounted type	Plastic Magazine (Tube)	100	Type name	CY25AAJ-8F

Note: Please confirm the specification about the shipping in detail.

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